



100V INPUT, 8.2V 30mA REGULATOR TRANSISTOR

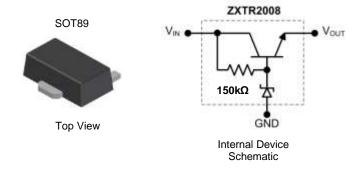
Description

The ZXTR2008Z monolithically integrates a transistor, Zener diode and resistor to function as a high voltage linear regulator. The device regulates with an 8.2V nominal output at 15mA. It is designed for use in high voltage applications where standard linear regulators cannot be used. This function is fully integrated into a SOT89 package, minimizing PCB area and reducing number of components when compared with a multi-chip discrete solution.

Applications

Supply Voltage Regulation in:

- Startup Switch in DC-DC Converters
- Networking
- **Telecommunications**
- Power over Ethernet (PoE)

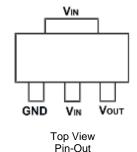


Features

- Series Linear Regulator Using Emitter-Follower Stage
- Input Voltage = 12V to 100V (For Regulated Output Voltage)
- Output Voltage = 8.2V ± 10%
- 150kΩ Resistor to Limit Quiescent Current
- Fully Integrated into a SOT89 package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 for High Reliability

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208
- Weight: 0.052 grams (Approximate)



Pin Name	Pin Function
VIN	Input Supply
GND	Power Ground
Vout	Voltage Output

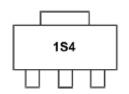
Ordering Information (Note 4)

Product	Package	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ZXTR2008Z-7	SOT89	1S4	7	12	1,000
ZXTR2008Z-13	SOT89	1S4	13	12	2,500

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



1S4 = Product Type Marking Code



Absolute Maximum Ratings (Voltage relative to GND, @TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	V _{IN}	-0.3 to 100	V
Continuous Input & Output Current	I _{IN,} I _{OUT}	400	mA
Peak Pulsed Input & Output Current	I _{IM} , I _{OM}	2	Α
Maximum Voltage applied to V _{OUT}	V _{OUT(MAX)}	Smaller of V _{IN} +8.2V or 14.5V	V

Maximum Current at $V_{IN} = 48V$ (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Continuous Output Current	(Note 7)	Іоит	42	mA
Pulsed Output Current	(Note 8)		800	m A
Pulsed Odiput Current	(Note 9)	Іом	160	mA mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	Ь	1.7	W
Fower Dissipation	(Note 6)	P _D	0.89	7 vv
Thermal Desigtance, Junction to Ambient	(Note 5)	D	59	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	112	20044
Thermal Resistance, Junction to Lead (Note 10)		$R_{\theta JL}$	20	°C/W
ermal Resistance, Junction to Case (Note 10)		$R_{\theta JC}$	15.7	
Recommended Operating Junction Temperature Ra	TJ	-40 to +125	°C	
Maximum Operating Junction and Storage Tempera	T _J , T _{STG}	-65 to +150	°C	

ESD Ratings (Note 11)

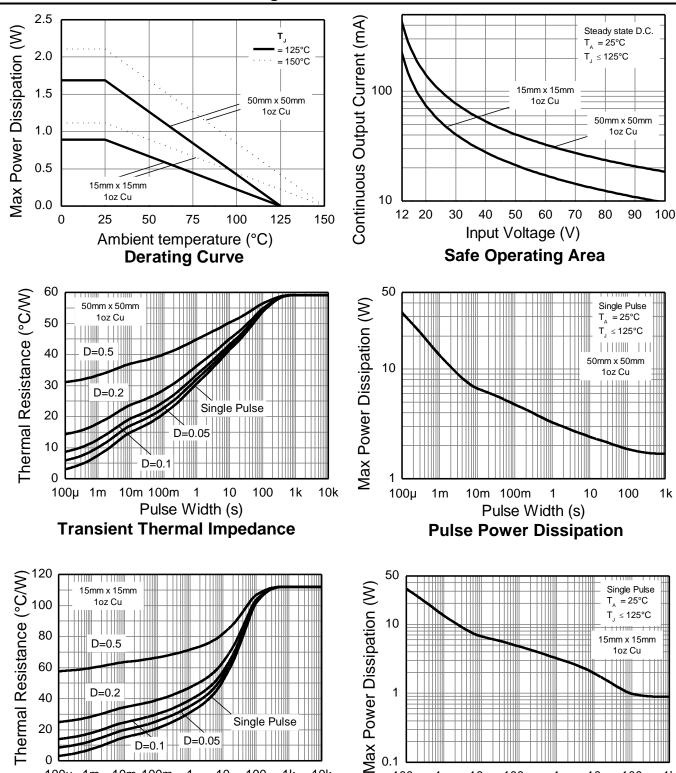
Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the exposed V_{IN} pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
- 6. Same as Note 5, except mounted on 15mm x 15mm 1oz copper.
- 7. Same as Note 5, whilst operating at V_{IN} = 48V. Refer to Safe Operating Area for other Input Voltages.
- 8. Same as Note 5, except measured with a single pulse width = 100 μ s and V $_{IN}$ = 48V.
- 9. Same as Note 5, except measured with a single pulse width = 10ms and $\ensuremath{V_{\text{IN}}}\xspace = 48\ensuremath{\text{V}}\xspace.$
- 10. $R_{\theta JL}$ = Thermal resistance from junction to solder-point (on the exposed V_{IN} pad). $R_{\theta JC}$ = Thermal resistance from junction to the top of case.
- 11. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information



Pulse Width (s)

10

100

10m 100m

100µ 1m

10k

1k



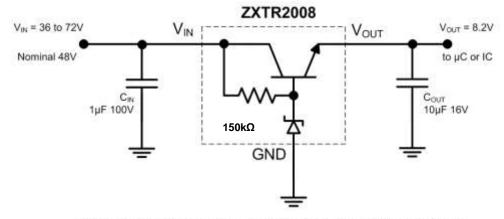
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Output Voltage (Note 12)	Vout	7.38	8.2	9.02	V	V _{IN} = 48V, I _{OUT} = 15mA
Line Regulation (Notes 12 & 13)	ΔV_{OUT}	-	10	300	mV	V _{IN} = 12 to 100V, I _{OUT} = 15mA
Temperature Coefficient	ΔV _{OUT} /ΔΤ	ı	10	ı	mV/°C	$T_J = -40$ °C to +125°C $V_{IN} = 48V$, $I_{OUT} = 15$ mA
Load Regulation (Notes 12 & 14)	ΔV _{OUT}		-180 -250	-350 -500	mV	I _{OUT} = 0.1 to 30mA, V _{IN} = 48V I _{OUT} = 0.1 to 100mA, V _{IN} = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	VIN(MIN)	12			V	_
Quiescent Current	IQ		275 650	500 900	μΑ	$V_{IN} = 48V$, $I_{OUT} = 10\mu A$ $V_{IN} = 100V$, $I_{OUT} = 10\mu A$
Power Supply Rejection Ratio	ΔVΙΝ / ΔVOUT	_	38	_	dB	C _{OUT} = 100nF, I _{OUT} = 15mA, V _{OUT} = 8.2V, V _{IN} =12 to 100V,f=100Hz

Notes:

- 12. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%
- 13. Line regulation $\Delta V_{OUT} = V_{OUT}(@V_{IN} = 100V) V_{OUT}(@V_{IN} = 12V)$
- 14. Load regulation $\Delta V_{OUT} = V_{OUT} (@ I_{OUT} = 30mA) V_{OUT} (@ I_{OUT} = 0.1mA)$
 - $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 100mA) V_{OUT}(@ I_{OUT} = 0.1mA)$

Typical Application Circuit



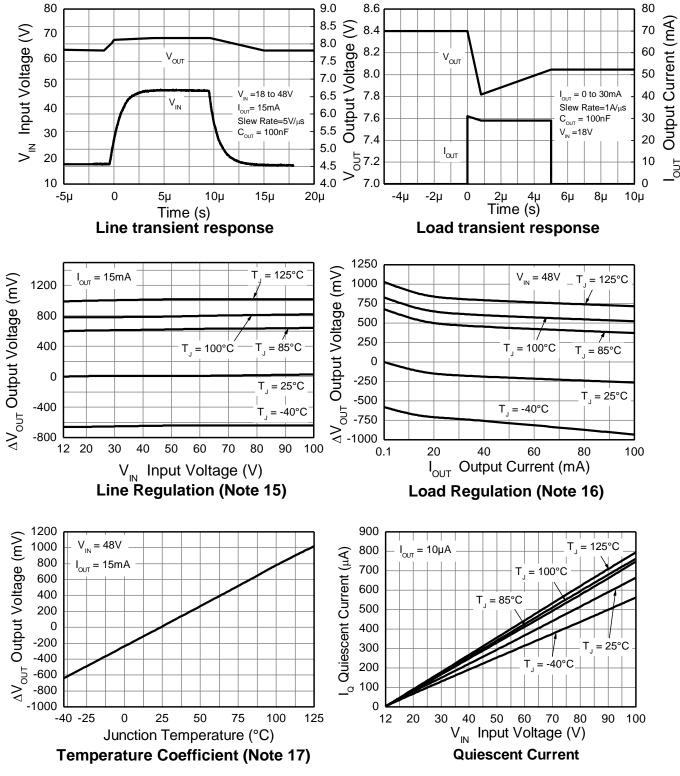
Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

Pin Functions

Pin Name	Pin Function	Notes
V _{IN}	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V_{OUT} regulated then $12V \le V_{IN} \le 100V$. It is recommended to connect a $1\mu F$ capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
		Outputs a regulated 8V when $12V \le V_{IN} \le 100V$. When $V_{IN} < 12V$, then V_{OUT} maximum = $V_{IN} - 1.5V$.
V _{OUT}	Voltage Output	The pin can be pulled high to a maximum of +14V with respect to GND, or +8V with respect to V_{IN} , whichever is lower. It is recommended to connect a 10 μ F capacitor to GND and a minimum of 10 μ A to be drawn from V_{OUT} to maintain regulation.







Notes: 15. Line regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 12V$, $I_{OUT} = 15mA$, $T_J = +25^{\circ}C$)

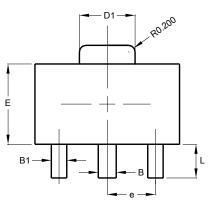
16. Load regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 48V$, $I_{OUT} = 0.1$ mA, $T_J = +25$ °C)

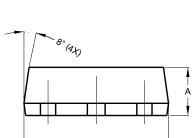
17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 48V$, $I_{OUT} = 15mA$, $T_J = +25^{\circ}C$)



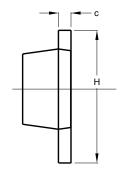
Package Outline Dimensions

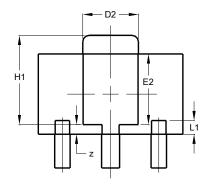
Please see http://www.diodes.com/package-outlines.html for the latest version.









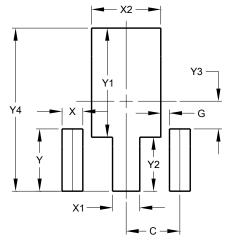


SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	-	1.50		
Н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
Z	0.20	0.40	0.30		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value
Dillielisions	(in mm)
С	1.500
G	0.244
Х	0.580
X1	0.760
X2	1.933
Υ	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530



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